### **Features**

- E<sup>2</sup> Programmable 524,288 x 1 and 1,048,576 x 1 bit Serial Memories Designed To Store Configuration Programs For Field Programmable Gate Arrays (FPGA)
- Simple Interface to SRAM FPGAs
- Compatible With Atmel AT6000, AT40K FPGAs, Altera EPF8K, EPF10K, EPF6K FPGAs, ORCA FPGAs, Xilinx XC3000, XC4000, XC5200 FPGAs, Motorola MPA1000 FPGAs
- Cascadable To Support Additional Configurations or Future Higher-density Arrays
- Low-power CMOS EEPROM Process
- Programmable Reset Polarity
- Available In PLCC Package (Pin Compatable across Product Family)
- In-System Programmable Via 2-Wire Bus
- Emulation of 24CXX Serial EPROMs
- Available in 3.3V  $\pm$  10% LV and 5V Versions
- System Friendly READY Pin

### Description

The AT17C512/010 and AT17LV512/010 (high-density AT17 Series) FPGA Configuration EEPROMs (Configurators) provide an easy-to-use, cost-effective configuration memory for Field Programmable Gate Arrays. The high-density AT17 Series is packaged in the popular 20-pin PLCC. The high-density AT17 Series family uses a simple serial-access procedure to configure one or more FPGA devices. The high-density AT17 Series organization supplies enough memory to configure one or multiple smaller FPGAs. The user can select the polarity of the reset function by programming one EEPROM byte. The devices also support a write protection mode and a system friendly READY pin, which signifies a "good" power level to the device and can be used to ensure reliable system power-up.

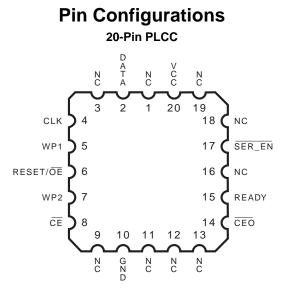
The high-density AT17 Series can be programmed with industry-standard programmers, and the Atmel ATDH2200 Programming board.



FPGA Configuration E<sup>2</sup>PROM Memory

512K and 1M

# AT17C512 AT17LV512 AT17C010 AT17LV010



Rev. 0944A-A-12/97





## **Controlling The High-Density AT17 Series Serial EEPROMs**

Most connections between the FPGA device and the Serial EEPROM are simple and self-explanatory:

- The DATA output of the high-density AT17 Series drives DIN of the FPGA devices.
- The master FPGA CCLK output drives the CLK input of the high-density AT17 Series.
- The CEO output of any AT17C/LV512/010 drives the CE input of the next AT17C/LV512/010 in a cascade chain of PROMs.
- SER\_EN must be connected to V<sub>CC</sub>, (except during ISP).

READY is available as an open-collector indicator of the device's RESET status; it is driven Low while the device is in its POWER-ON RESET cycle and released (tri-stated) when the cycle is complete.

There are two different ways to use the inputs  $\overline{CE}$  and  $\overline{OE}$ , as shown in the AC Characteristics waveforms.

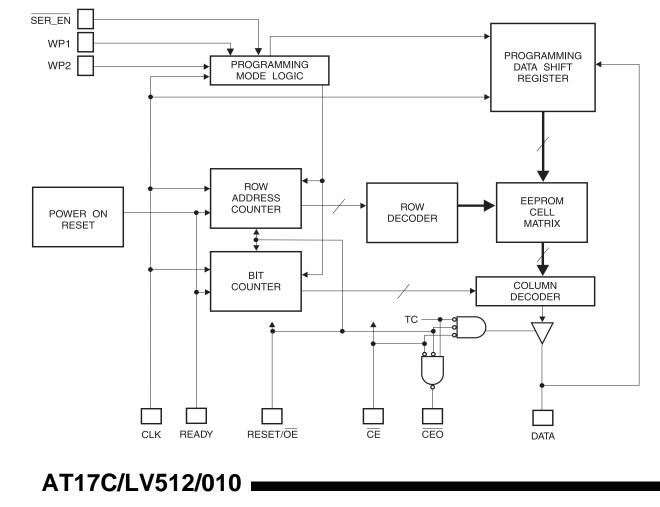
#### **Condition 1**

The simplest connection is to have the FPGA  $D/\overline{P}$  output drive both  $\overline{CE}$  and RESET/ $\overline{OE}$  in parallel (Figure 1). Due to

its simplicity, however, this method will fail if the FPGA receives an external reset condition during the configuration cycle. If a system reset is applied to the FPGA, it will abort the original configuration and then reset itself for a new configuration, as intended. Of course, the high-density AT17 Series does not see the external reset signal and will not reset its internal address counters and, consequently, will remain out of sync with the FPGA for the remainder of the configuration cycle.

#### **Condition 2**

The FPGA D/P output drives only the  $\overline{CE}$  input of the highdensity AT17 Series, while its  $\overline{OE}$  input is driven by the inversion of the input to the FPGA RESET input pin. This connection works under all normal circumstances, even when the user aborts a configuration before D/P has gone High. A High level on the RESET/ $\overline{OE}$  input to the AT17C/LVxxx – during FPGA reset – clears the Configurator's internal address pointer, so that the reconfiguration starts at the beginning. The high-density AT17 Series does not require an inverter since the RESET polarity is programmable.



## **Block Diagram**

## **Pin Configurations**

| 20<br>PLCC | Name            | I/O | Description   |
|------------|-----------------|-----|---|
| 2          | DATA            | I/O | Three-state DATA output for reading. Input/Output pin for programming.  |
| 4          | CLK             | I   | Clock input. Used to increment the internal address and bit counter for reading and programming.  |
| 5          | WP1             | I   | WRITE PROTECT (1). Used to protect portions of memory during programming. See programming guide for details.  |
| 6          | RESET/OE        | Ι   | RESET/Output Enable input (when $\overline{\text{SER}}_{EN}$ is High). A Low level on both the $\overline{\text{CE}}$ and RESET/ $\overline{\text{OE}}$ inputs enables the data output driver. A High level on RESET/ $\overline{\text{OE}}$ resets both the address and bit counters. The logic polarity of this input is programmable as either RESET/ $\overline{\text{OE}}$ or RESET/ $\overline{\text{OE}}$ . This document describes the pin as RESET/ $\overline{\text{OE}}$ . |
| 7          | WP2             | I   | WRITE PROTECT (2). Used to protect portions of memory during programming. See programming guide for details.  |
| 8          | CE              | I   | Chip Enable input. Used for device selection. A Low level on both $\overline{CE}$ and $\overline{OE}$ enables the data output driver. A High level on $\overline{CE}$ disables both the address and bit counters and forces the device into a low power mode. Note this pin will <u>not</u> enable/disable the device in 2-wire Serial Programming mode (i.e., when $\overline{SER}$ _EN is Low).   |
| 10         | GND             |     | Ground pin.   |
| 14         | CEO             | 0   | Chip Enable Out output. This signal is asserted Low on the clock cycle following the last bit read from the memory. It will stay Low as long as CE and $\overline{OE}$ are both Low. It will then follow $\overline{CE}$ until $\overline{OE}$ goes High. Thereafter, $\overline{CEO}$ will stay High until the entire PROM is read again and senses the status of RESET polarity.  |
|            | A2              | I   | Device selection input, A2. This is used to enable (or select) the device during programming, when SER_EN is Low (see Programming Guide for more details)   |
| 15         | READY           | 0   | Open collector reset state indicator. Driven Low during power-up reset, released when power-up is complete. (Recommend a $4.7$ K $\Omega$ Pull-up on this pin if used).   |
| 17         | SER_EN          | I   | Serial enable is normally high during FPGA loading operations. Bringing SER_EN Low, enables the two wire serial interface mode for programming.   |
| 20         | V <sub>CC</sub> |     | +3.3V/+5V power supply pin.   |

## Absolute Maximum Ratings\*

| Operating Temperature55°C to +125°C                              | , |
|--|---|
| Storage Temperature65°C to +150°C                                |   |
| Voltage on Any Pin with Respect to Ground0.1V to $V_{CC}$ + 0.5V |   |
| Supply Voltage (V <sub>CC</sub> )0.5V to +7.0V                   |   |
| Maximum Soldering Temp. (10 s @ 1/16 in.)260°C                   |   |
| ESD (R <sub>ZAP</sub> = 1.5K, C <sub>ZAP</sub> = 100 pF)         |   |

\*NOTICE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those listed under Operating Conditions is not implied. Exposure to Absolute Maximum Ratings conditions for extended periods of time may affect device reliability.





### **FPGA Master Serial Mode Summary**

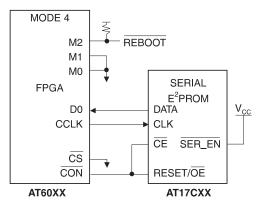
The I/O and logic functions of the FPGA and their associated interconnections are established by a configuration program. The program is loaded either automatically upon power up, or on command, depending on the state of the three FPGA mode pins. In Master Mode, the FPGA automatically loads the configuration program from an external memory. The Serial Configuration EEPROM has been designed for compatibility with the Master Serial Mode.

#### Cascading Serial Configuration EEPROMs

For multiple FPGAs configured as a daisy-chain, or for future FPGAs requiring larger configuration memories, cascaded Configurators provide additional memory.

As the last bit from the first Configurator is read, the clock signal to the Configurator asserts its CEO output Low and disables its DATA line. The second Configurator recognizes the Low level on its CE input and enables its DATA output.

Figure 1. Condition 1 Connection



After configuration is complete, the address counters of all cascaded Configurators are reset if the reset signal drives the RESET/OE on each Configurator to its active (High) level.

If the address counters are not to be reset upon completion, then the RESET/OE inputs can be tied to ground. For more details, please reference the AT17C Series Programming Guide.

#### **Programming Mode**

The programming mode is entered by bringing  $\overline{SER\_EN}$ Low. In this mode the chip can be programmed by the 2wire interface. The programming is done at V<sub>CC</sub> supply only. Programming super voltages are generated inside the chip. See the Programming Specification for Atmel's Configuration Memories Application Note for further information. The AT17C Series parts are read/write at 5V nominal. The AT17LV parts are read/write at 3.3V nominal.

## AT17C/LVXXX Reset Polarity

The AT17C/LVXXX lets the user choose the reset polarity as either RESET/OE or RESET/OE.

## **Standby Mode**

The AT17C/LVXXX enters a low-power standby mode whenever  $\overline{CE}$  is asserted High. In this mode, the Configurator consumes less than 0.5mA at 5.0 volts. The output remains in a high impedance state regardless of the state of the  $\overline{OE}$  input.

#### **Operating Conditions**

|                 |             |   | AT17CXXX    | AT17LVXXX |       |
|-----------------|-------------|---|-------------|-----------|-------|
| Symbol          | Description |   | Min/Max     | Min/Max   | Units |
|                 | Commercial  | Supply voltage relative to GND<br>-0°C to +70°C   | 4.75 / 5.25 | 3.0 / 3.6 | V     |
| V <sub>CC</sub> | Industrial  | Supply voltage relative to GND<br>-40°C to +85°C  | 4.5 / 5.5   | 3.0 / 3.6 | V     |
|                 | Military    | Supply voltage relative to GND<br>-55°C to +125°C | 4.5 / 5.5   | 3.0 / 3.6 | V     |

## AT17C/LV512/010

# AT17C/LV512/010

## **DC** Characteristics

 $V_{CC}$  = 5V  $\pm$  5% Commercial / 5V  $\pm$  10% Ind./Mil.

| Symbol           | Description  |                     | Min  | Max             | Units |
|------------------|--|---------------------|------|-----------------|-------|
| V <sub>IH</sub>  | High-level input voltage   |                     | 2.0  | V <sub>CC</sub> | V     |
| V <sub>IL</sub>  | Low-level input voltage  |                     | 0    | 0.8             | V     |
| V <sub>OH</sub>  | High-level output voltage (I <sub>OH</sub> = -4 mA)                        | O                   | 3.86 |                 | V     |
| V <sub>OL</sub>  | Low-level output voltage (I <sub>OL</sub> = +4 mA)                         | Commercial          |      | 0.32            | V     |
| V <sub>OH</sub>  | High-level output voltage (I <sub>OH</sub> = -4 mA)                        | la du stais l       | 3.76 |                 | V     |
| V <sub>OL</sub>  | Low-level output voltage ( $I_{OL} = +4 \text{ mA}$ )                      | Industrial          |      | 0.37            | V     |
| V <sub>OH</sub>  | High-level output voltage (I <sub>OH</sub> = -4 mA)                        | NALL'A - ma         | 3.7  |                 | V     |
| V <sub>OL</sub>  | Low-level output voltage ( $I_{OL} = +4 \text{ mA}$ )                      | Military            |      | 0.4             | V     |
| I <sub>CCA</sub> | Supply current, active mode (at FMAX)                                      |                     |      | 10              | mA    |
| ΙL               | Input or output leakage current (V <sub>IN</sub> = V <sub>CC</sub> or GND) |                     | -10  | 10              | μA    |
| I <sub>CCS</sub> |  | Commercial          |      | 0.5             | mA    |
|                  | Supply current, standby mode   | Industrial/Military |      | 0.5             | mA    |

## **DC Characteristics**

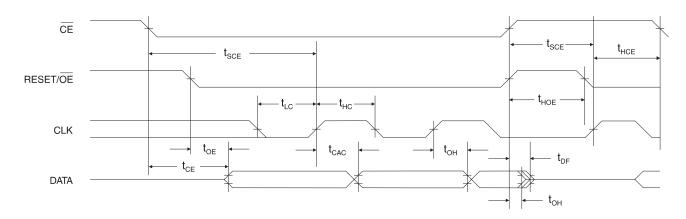
 $V_{CC} = 3.3V \pm 10\%$ 

| Symbol           | Description  |                     | Min | Max             | Units |
|------------------|--|---------------------|-----|-----------------|-------|
| V <sub>IH</sub>  | High-level input voltage   |                     | 2.0 | V <sub>CC</sub> | V     |
| V <sub>IL</sub>  | Low-level input voltage  |                     | 0   | 0.8             | V     |
| V <sub>OH</sub>  | High-level output voltage (I <sub>OH</sub> = -2.5 mA)                      | Commercial          | 2.4 |                 | V     |
| V <sub>OL</sub>  | Low-level output voltage ( $I_{OL} = +3 \text{ mA}$ )                      | Commercial          |     | 0.4             | V     |
| V <sub>OH</sub>  | High-level output voltage (I <sub>OH</sub> = -2 mA)                        | la ductoia l        | 2.4 |                 | V     |
| V <sub>OL</sub>  | Low-level output voltage ( $I_{OL} = +3 \text{ mA}$ )                      | - Industrial        |     | 0.4             | V     |
| V <sub>OH</sub>  | High-level output voltage (I <sub>OH</sub> = -2 mA)                        | N 4114              | 2.4 |                 | V     |
| V <sub>OL</sub>  | Low-level output voltage ( $I_{OL} = +2.5 \text{ mA}$ )                    | – Military          |     | 0.4             | V     |
| I <sub>CCA</sub> | Supply current, active mode  |                     |     | 5               | mA    |
| ΙL               | Input or output leakage current (V <sub>IN</sub> = V <sub>CC</sub> or GND) |                     | -10 | 10              | μA    |
| I <sub>CCS</sub> | Overally average stars they are de-  | Commercial          |     | 100             | μA    |
|                  | Supply current, standby mode   | Industrial/Military |     | 100             | μA    |

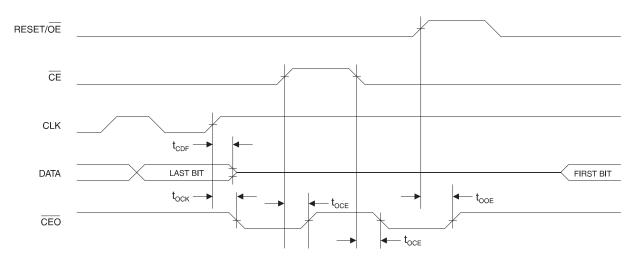




## **AC Characteristics**



## **AC Characteristics When Cascading**



AT17C/LV512/010

## AT17C/LV512/010

## AC Characteristics for AT17C512/010

| $V_{CC} = 5V \pm 8$ | 5% Commercial / $V_{CC}$ = 5V ± 10% Ind./Mil |
|---------------------|--|
|                     |  |

|                                |   | Commercial/Industrial |     | Military |     |       |
|--------------------------------|---|-----------------------|-----|----------|-----|-------|
| Symbol                         | Description   | Min                   | Max | Min      | Max | Units |
| T <sub>OE</sub> <sup>(2)</sup> | OE to Data Delay  |                       | 30  |          | 35  | ns    |
| $T_{CE}^{(2)}$                 | CE to Data Delay  |                       | 45  |          | 45  | ns    |
| $T_{CAC}^{(2)}$                | CLK to Data Delay   |                       | 50  |          | 50  | ns    |
| T <sub>OH</sub> <sup>(2)</sup> | Data Hold From $\overline{CE}$ , $\overline{OE}$ , or CLK | 0                     |     | 0        |     | ns    |
| $T_{DF}^{(3)}$                 | $\overline{CE}$ or $\overline{OE}$ to Data Float Delay    |                       | 50  |          | 50  | ns    |
| T <sub>LC</sub>                | CLK Low Time  | 20                    |     | 20       |     | ns    |
| T <sub>HC</sub>                | CLK High Time   | 20                    |     | 20       |     | ns    |
| T <sub>SCE</sub>               | CE Setup Time to CLK (to guarantee proper counting)       | 20                    |     | 25       |     | ns    |
| T <sub>HCE</sub>               | CE Hold Time to CLK (to guarantee proper counting)        | 0                     |     | 0        |     | ns    |
| T <sub>HOE</sub>               | OE High Time (Guarantees Counter Is Reset)                | 20                    |     | 20       |     | ns    |
| F <sub>MAX</sub>               | MAX Input Clock Frequency                                 | 15                    |     | 15       |     | MHz   |
| V <sub>RDY</sub>               | Ready Pin Open Collector Voltage                          | 1.2                   | 2.2 | 1.2      | 2.2 | V     |

## AC Characteristics for AT17C512/010 When Cascading

 $V_{CC}$  = 5V± 5% Commercial /  $V_{CC}$  = 5V ± 10% Ind./Mil.

|                                 |                         | Commercial | Commercial/Industrial |     | Military |       |
|---------------------------------|-------------------------|------------|-----------------------|-----|----------|-------|
| Symbol                          | Description             | Min        | Max                   | Min | Max      | Units |
| T <sub>CDF</sub> <sup>(3)</sup> | CLK to Data Float Delay |            | 50                    |     | 50       | ns    |
| T <sub>OCK</sub> <sup>(2)</sup> | CLK to CEO Delay        |            | 35                    |     | 40       | ns    |
| T <sub>OCE</sub> <sup>(2)</sup> | CE to CEO Delay         |            | 35                    |     | 35       | ns    |
| T <sub>OOE</sub> <sup>(2)</sup> | RESET/OE to CEO Delay   |            | 30                    |     | 30       | ns    |

Notes: 1. Preliminary specifications for military operating range only.

2. AC test load = 50 pF.

3. Float delays are measured with 5 pF AC loads. Transition is measured  $\pm$  200 mV from steady state active levels.





## AC Characteristics for AT17LV512/010

 $V_{CC}=3.3V\pm10\%$ 

|                                 |   | Commercial/Industrial |     | Military |     |       |
|---------------------------------|---|-----------------------|-----|----------|-----|-------|
| Symbol                          | Description   | Min                   | Max | Min      | Max | Units |
| T <sub>OE</sub> <sup>(2)</sup>  | OE to Data Delay  |                       | 50  |          | 55  | ns    |
| T <sub>CE</sub> <sup>(2)</sup>  | CE to Data Delay  |                       | 55  |          | 60  | ns    |
| T <sub>CAC</sub> <sup>(2)</sup> | CLK to Data Delay   |                       | 55  |          | 60  | ns    |
| Т <sub>ОН</sub>                 | Data Hold From $\overline{CE}$ , $\overline{OE}$ , or CLK | 0                     |     | 0        |     | ns    |
| T <sub>DF</sub> <sup>(3)</sup>  | CE or OE to Data Float Delay                              |                       | 50  |          | 50  | ns    |
| T <sub>LC</sub>                 | CLK Low Time  | 25                    |     | 25       |     | ns    |
| т <sub>нс</sub>                 | CLK High Time   | 25                    |     | 25       |     | ns    |
| T <sub>SCE</sub>                | CE Setup Time to CLK (to guarantee proper counting)       | 30                    |     | 35       |     | ns    |
| T <sub>HCE</sub>                | TE Hold Time to CLK (to guarantee proper counting)        | 0                     |     | 0        |     | ns    |
| T <sub>HOE</sub>                | OE High Time (Guarantees Counter Is Reset)                | 25                    |     | 25       |     | ns    |
| F <sub>MAX</sub> <sup>(4)</sup> | MAX Input Clock Frequency                                 | 15                    |     | 10       |     | MHz   |
| V <sub>RDY</sub>                | Ready Pin Open Collector Voltage                          | 1.2                   | 2.2 | 1.2      | 2.2 | V     |

2. AC test load = 50 pF.

3. Float delays are measured with 5 pF AC loads. Transition is measured  $\pm$  200 mV from steady state active levels.

4. During cascade  $F_{MAX}$  = 12.5 MHz.

## AC Characteristics for AT17LV512/010 When Cascading

 $V_{CC}$  = 3.3V  $\pm$  10%

|                                 |                         | Commercial/Industrial |     | Military |     |       |
|---------------------------------|-------------------------|-----------------------|-----|----------|-----|-------|
| Symbol                          | Description             | Min                   | Max | Min      | Max | Units |
| T <sub>CDF</sub> <sup>(3)</sup> | CLK to Data Float Delay |                       | 50  |          | 50  | ns    |
| T <sub>OCK</sub> <sup>(2)</sup> | CLK to CEO Delay        |                       | 50  |          | 55  | ns    |
| T <sub>OCE</sub> <sup>(2)</sup> | CE to CEO Delay         |                       | 35  |          | 40  | ns    |
| T <sub>OOE</sub> <sup>(2)</sup> | RESET/OE to CEO Delay   |                       | 35  |          | 35  | ns    |

AT17C/LV512/010

# AT17C/LV512/010

## **Ordering Information - 5V Devices**

| Memory Size | Ordering Code | Package | Operation Range               |
|-------------|---------------|---------|-------------------------------|
| 512K        | AT17C512-10JC | 20J     | Commercial<br>(0°C to 70°C)   |
|             | AT17C512-10JI | 20J     | Industrial<br>(-40°C to 85°C) |
| 1M          | AT17C010-10JC | 20J     | Commercial<br>(0°C to 70°C)   |
|             | AT17C010-10JI | 20J     | Industrial<br>(-40°C to 85°C) |

## **Ordering Information - 3.3V Devices**

| Memory Size | Ordering Code  | Package | Operation Range               |
|-------------|----------------|---------|-------------------------------|
| 512K        | AT17LV512-10JC | 20J     | Commercial<br>(0°C to 70°C)   |
|             | AT17LV512-10JI | 20J     | Industrial<br>(-40°C to 85°C) |
| 1M          | AT17LV010-10JC | 20J     | Commercial<br>(0°C to 70°C)   |
|             | AT17LV010-10JI | 20J     | Industrial<br>(-40°C to 85°C) |

| Package Type |   |
|--------------|---|
| 20J          | 20 Lead, Plastic J-Leaded Chip Carrier (PLCC) |

